

May 10, 2019



Media Alert: Student Innovators Compete at Intel ISEF for More Than \$5 Million in Awards and Scholarships

SANTA CLARA, Calif.--(BUSINESS WIRE)-- The [Intel International Science and Engineering Fair](#) (Intel ISEF), a program of Society for Science & the Public and the world's largest international pre-college science competition, will take place in Phoenix from May 12 to 17.

This press release features multimedia. View the full release here:

<https://www.businesswire.com/news/home/20190510005050/en/>

From left: Meghana Bollimpalli, Oliver Nicholls and Dhruvik Parikh celebrate on Friday, May 18, 2018, at the 2018 Intel International Science and Engineering Fair, a program of Society for Science & the Public and the world's largest international pre-college science competition. Nicholls, of Sydney, Australia, was awarded first place for designing and building a prototype of an autonomous robotic window cleaner for commercial buildings. Bollimpalli, of Little Rock, Arkansas, and Parikh, of Bothell, Washington, received Intel Foundation Young Scientist Awards. (Credit: Intel Corporation)

- More than 1,800 high school students selected from 423 affiliate fairs in 80 countries, regions and territories will showcase cutting-edge research and inventions.

- Finalists will compete for approximately \$5 million in awards and scholarships.
- The full list of finalists is available in the [event program](#). This year, 21 finalists are from the local Phoenix area.

Media must be registered to attend. To register, contact Aparna Paul, Society for Science & the Public, at apaul@societyforscience.org.

When: Public Exhibition of Projects

Thursday, May 16, from 9 a.m.-1 p.m. MST

- This is the best opportunity for registered media to see, interview, film and photograph students from across the country and the world who are working to find solutions to global challenges through science, technology, engineering and math research. This year, research topics range from autonomous vehicles to 3D printing to machine learning.

Awards Ceremony

Friday, May 17, from 9 a.m.-11:30 a.m. MST

- Registered media representatives are invited to attend the awards ceremony where the winners will be announced. The top prizes awarded by the Intel Foundation include the \$75,000 Gordon E. Moore Award, named after the Intel co-founder and fellow scientist. Two additional top winning projects will receive Intel Foundation Young Scientist Awards of \$50,000 each.

Who: Maya Ajmera, president and CEO of Society for Science & the Public and publisher of *Science News*
Pia Wilson-Body, president of the Intel Foundation

Where: Phoenix Convention Center
100 N. 3rd St., Phoenix, AZ 85004

Quotes: “Overcoming the challenges facing our world requires a variety of perspectives – including young minds that understand the value of curiosity and have a deep passion for learning,” said Pia Wilson-Body, president of the Intel Foundation. “By using science and innovation to further our collective understanding of the world, the students at the Intel International Science and Engineering Fair are building the foundation for a brighter tomorrow.”

“The Intel International Science and Engineering Fair brings together students from different backgrounds, geographic locations and life experiences, demonstrating how these unique perspectives are essential to uncovering solutions to our world’s most intractable challenges,” said Maya Ajmera, president and CEO of Society for Science & the Public and publisher of *Science News*. “The amazing ideas showcased here are a testament to the power of science and education to make the world a better place.”

More Info: For information on Intel’s commitment to education, visit [Intel’s Corporate Social Responsibility page](#) and join the conversation on [Facebook](#) and [Twitter](#).

To learn more about Society for Science & the Public, visit its [website](#), and follow the group on [Facebook](#), [Twitter](#), [Instagram](#) and Snapchat at Society4Science.

Find images, videos and other news from the 2019 Intel ISEF on the Intel Newsroom’s [2019 ISEF Press Kit](#).

About Intel

Intel (NASDAQ: INTC), a leader in the semiconductor industry, is shaping the data-centric future with computing and communications technology that is the foundation of the world’s innovations. The company’s engineering expertise is helping address the world’s greatest challenges as well as helping secure, power and connect billions of devices and the infrastructure of the smart, connected world – from the cloud to the network to the edge and everything in between. Find more information about Intel at newsroom.intel.com and

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